507154865 03/01/2022

### PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KUAN-YI LIN	01/26/2022
CHEN YANG	01/26/2022
PO-CHIANG HSIEH	01/26/2022
PEI-SHAN LIU	01/26/2022

#### **RECEIVING PARTY DATA**

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Street Address:	30F-1, NO.118, CIYUN RD., EAST DIST.,	
City:	HSINCHU CITY	
State/Country:	TAIWAN	
Postal Code:	300	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17683378

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	109330-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	03/01/2022

#### **Total Attachments: 4**

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the application.

# DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

⊠ D	Peclaration Submitted With Initial Filing
OR	
□ D	eclaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)
	(Title of the Invention)
UNI	DER-SCREEN FINGERPRINT SENSING DEVICE AND FINGERPRINT SENSING METHOD
As a l	below named inventor (hereinafter designated as the undersigned), I hereby
decla	re that:
This	declaration is directed to:
<b>⊠</b> 7	Γhe attached application,
OR	
□ \	United States Application Number or PCT International application number
_	Filed on
The a	above-identified application was made or authorized to be made by me.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I believe I am the original inventor or an original joint inventor of a claimed invention in

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EGIS-21006-US 109330-US-PA

**DECLARATION AND ASSIGNMENT** 

FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS, 1. Egis Technology Inc.

of

30F-1, No.118, Ciyun Rd., East Dist., Hsinchu City 300, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the

same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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PATENT REEL: 059139 FRAME: 0560

## DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

Signature: Change on		
Legal Name of Sole or First Inventor: Kuan-Yi Lin		
Residence: Hsinchu City, Taiwan		
Mailing Address: c/o 30F-1, No.118, Ciyun Rd.,	East Dist., Hsinchu City 300, Taiwan, R.O.C.	
Signature:	Date:	
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Signature:	Date:	
Legal Name of Additional Joint Inventor, if any: Po-Chiang Hsieh		
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Mailing Address: c/o 30F-1, No.118, Ciyun Rd., East Dist., Hsinchu City 300, Taiwan, R.O.C.		
Signature:	Date:	
Legal Name of Additional Joint Inventor, if any: Pei-Shan Liu		
Residence: Hsinchu City, Taiwan		
Mailing Address: c/o 30F-1, No.118, Ciyun Rd., East Dist., Hsinchu City 300, Taiwan, R.O.C.		

### DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

Signature:	Date:	
Legal Name of Sole or First Inventor: Kuan-Yi Lin		
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Signature: Chen Yang	Date: >032 / ( / 26	
Legal Name of Additional Joint In		
Residence: Hsinchu City, Taiwan		
Mailing Address: c/o 30F-1, No.118, Ciyun Rd., East Dist., Hsinchu City 300, Taiwan, R.O.C.		
Signature: P. Chiang	Hsieh	
Legal Name of Additional Joint Inventor, if any: Po-Chiang Hsieh		
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Signature: Pet Shah	Lia Date: 2022/1/26	
Legal Name of Additional Joint Inventor, if any: Pei-Shan Liu		
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